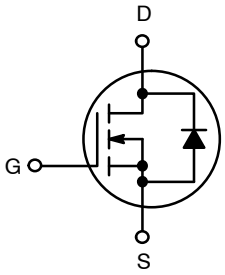
# MOSFET – Power, N-Channel, SUPERFET® III, FRFET®

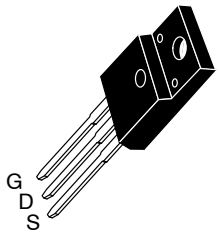
## 650 V, 24 A, 150 mΩ

# NTPF150N65S3HF

| $V_{DSS}$ | $R_{DS(ON)}$ MAX | $I_D$ MAX |
|---|---|---|
| 650 V | 150 mΩ @ 10 V | 24 A |




**POWER MOSFET**




**TO−220 FULLPAK**
**CASE 221D**

### Description

SUPERFET III MOSFET is **onsemi**'s brand−new high voltage super−junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on−resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET is very suitable for the various power system for miniaturization and higher efficiency.

SUPERFET III FRFET MOSFET's optimized reverse recovery performance of body diode can remove additional component and improve system reliability.

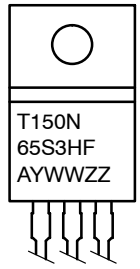
### Features

- 700 V @ $T_J$ = 150°C
- Typ. $R_{DS(on)}$ = 121 mΩ
- Ultra Low Gate Charge (Typ. $Q_g$ = 43 nC)
- Low Effective Output Capacitance (Typ. $C_{oss(eff.)}$ = 400 pF)
- 100% Avalanche Tested
- These Devices are Pb−Free and are RoHS Compliant

### Applications

- Telecom / Server Power Supplies
- Industrial Power Supplies
- EV Charger
- UPS / Solar

### MARKING DIAGRAM




| | |
|---|---|
| T150N65S3HF | = Specific Device Code |
| A | = Assembly Location |
| YWW | = Date Code (Year & Week) |
| ZZ | = Assembly Lot |

### ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

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**ABSOLUTE MAXIMUM RATINGS** ($T_C$ = 25°C, Unless otherwise noted)

| Symbol | Parameter | | Value | Unit |
|---|---|---|---|---|
| $V_{DSS}$ | Drain to Source Voltage | | 650 | V |
| $V_{GSS}$ | Gate to Source Voltage | – DC | ±30 | V |
| | | – AC (f > 1 Hz) | ±30 | |
| $I_D$ | Drain Current | – Continuous ($T_C$ = 25°C) | 24* | A |
| | | – Continuous ($T_C$ = 100°C) | 15.2* | |
| $I_{DM}$ | Drain Current | – Pulsed (Note 1) | 60* | A |
| $E_{AS}$ | Single Pulsed Avalanche Energy (Note 2) | | 275 | mJ |
| $I_{AS}$ | Avalanche Current (Note 2) | | 3.8 | A |
| $E_{AR}$ | Repetitive Avalanche Energy (Note 1) | | 1.92 | mJ |
| dv/dt | MOSFET dv/dt | | 100 | V/ns |
| | Peak Diode Recovery dv/dt (Note 3) | | 50 | |
| $P_D$ | Power Dissipation | ($T_C$ = 25°C) | 192 | W |
| | | – Derate Above 25°C | 1.54 | W/°C |
| $T_J$, $T_{STG}$ | Operating and Storage Temperature Range | | –55 to +150 | °C |
| $T_L$ | Maximum Lead Temperature for Soldering, 1/8″ from Case for 5 seconds | | 300 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
*Drain current limited by maximum junction temperature.
1. Repetitive rating: pulse−width limited by maximum junction temperature.
2. $I_{AS}$ = 3.8 A, $R_G$ = 25 Ω, starting $T_J$ = 25°C.
3. $I_{SD} \le$ 12 A, di/dt ≤ 200 A/μs, $V_{DD} \le$ 400 V, starting $T_J$ = 25°C.

**THERMAL CHARACTERISTICS**

| Symbol | Parameter | Value | Unit |
|---|---|---|---|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max. | 3.22 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient, Max. | 62.5 | |

**PACKAGE MARKING AND ORDERING INFORMATION**

| Part Number | Top Marking | Package | Packing Method | Reel Size | Tape Width | Shipping |
|---|---|---|---|---|---|---|
| NTPF150N65S3HF | T150N65S3HF | TO−220 FULLPACK | Tube | N/A | N/A | 1000 Units |


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**ELECTRICAL CHARACTERISTICS** ($T_C$ = 25°C unless otherwise noted)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---|---|---|---|---|---|---|
| **OFF CHARACTERISTICS** | | | | | | |
| $BV_{DSS}$ | Drain to Source Breakdown Voltage | $V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 25°C | 650 | | | V |
| | | $V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 150°C | 700 | | | V |
| $\Delta BV_{DSS}$ / $\Delta T_J$ | Breakdown Voltage Temperature Coefficient | $I_D$ = 15 mA, Referenced to 25°C | | 0.62 | | V/°C |
| $I_{DSS}$ | Zero Gate Voltage Drain Current | $V_{DS}$ = 650 V, $V_{GS}$ = 0 V | | | 10 | μA |
| | | $V_{DS}$ = 520 V, $T_C$ = 125°C | | 67 | | |
| $I_{GSS}$ | Gate to Body Leakage Current | $V_{GS}$ = ±30 V, $V_{DS}$ = 0 V | | | ±100 | nA |
| **ON CHARACTERISTICS** | | | | | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS}$ = $V_{DS}$, $I_D$ = 0.54 mA | 3.0 | | 5.0 | V |
| $R_{DS(on)}$ | Static Drain to Source On Resistance | $V_{GS}$ = 10 V, $I_D$ = 12 A | | 121 | 150 | mΩ |
| $g_{FS}$ | Forward Transconductance | $V_{DS}$ = 20 V, $I_D$ = 12 A | | 14 | | S |
| **DYNAMIC CHARACTERISTICS** | | | | | | |
| $C_{iss}$ | Input Capacitance | $V_{DS}$ = 400 V, $V_{GS}$ = 0 V, f = 1 MHz | | 1985 | | pF |
| $C_{oss}$ | Output Capacitance | | | 40 | | pF |
| $C_{oss(eff.)}$ | Effective Output Capacitance | $V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V | | 400 | | pF |
| $C_{oss(er.)}$ | Energy Related Output Capacitance | $V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V | | 71 | | pF |
| $Q_{g(tot)}$ | Total Gate Charge at 10 V | $V_{DS}$ = 400 V, $I_D$ = 12 A, $V_{GS}$ = 10 V (Note 4) | | 43 | | nC |
| $Q_{gs}$ | Gate to Source Gate Charge | | | 13 | | nC |
| $Q_{gd}$ | Gate to Drain “Miller” Charge | | | 17 | | nC |
| ESR | Equivalent Series Resistance | f = 1 MHz | | 5.0 | | Ω |
| **SWITCHING CHARACTERISTICS** | | | | | | |
| $t_{d(on)}$ | Turn-On Delay Time | $V_{DD}$ = 400 V, $I_D$ = 12 A, $V_{GS}$ = 10 V $R_g$ = 4.7 Ω (Note 4) | | 21 | | ns |
| $t_r$ | Turn-On Rise Time | | | 19 | | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | | 63 | | ns |
| $t_f$ | Turn-Off Fall Time | | | 14 | | ns |
| **SOURCE-DRAIN DIODE CHARACTERISTICS** | | | | | | |
| $I_S$ | Maximum Continuous Source to Drain Diode Forward Current | | | | 24 | A |
| $I_{SM}$ | Maximum Pulsed Source to Drain Diode Forward Current | | | | 60 | A |
| $V_{SD}$ | Source to Drain Diode Forward Voltage | $V_{GS}$ = 0 V, $I_{SD}$ = 12 A | | | 1.3 | V |
| $t_{rr}$ | Reverse Recovery Time | $V_{DD}$ = 400 V, $I_{SD}$ = 12 A, $dI_F/dt$ = 100 A/μs | | 88 | | ns |
| $Q_{rr}$ | Reverse Recovery Charge | | | 306 | | nC |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.



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## TYPICAL CHARACTERISTICS

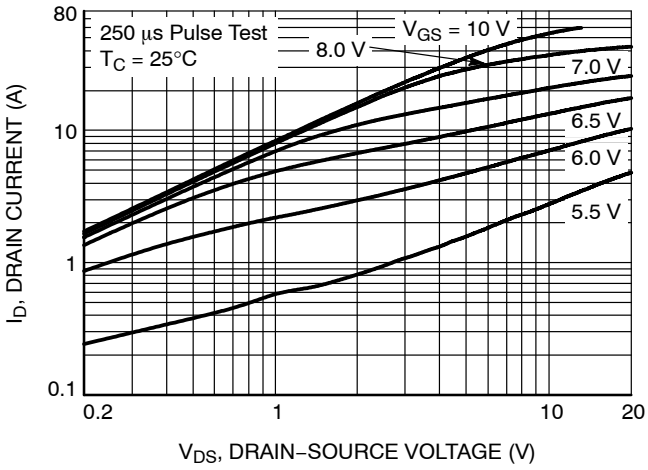



**Figure 1. On−Region Characteristics**

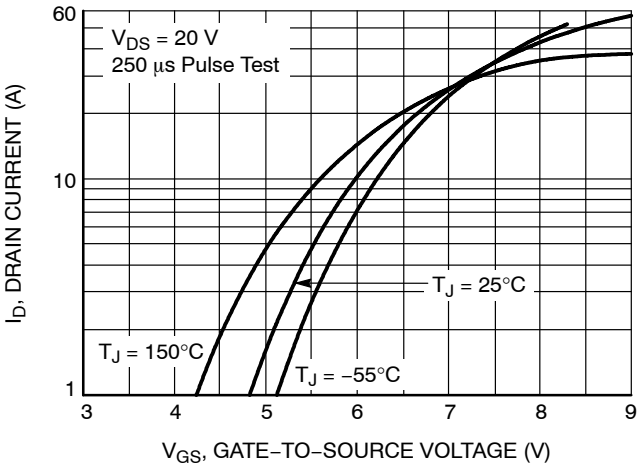



**Figure 2. Transfer Characteristics**

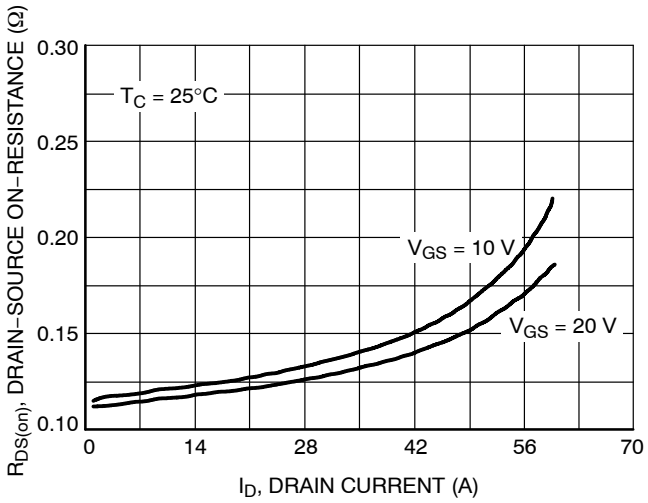



**Figure 3. On−Resistance Variation vs. Drain Current and Gate Voltage**

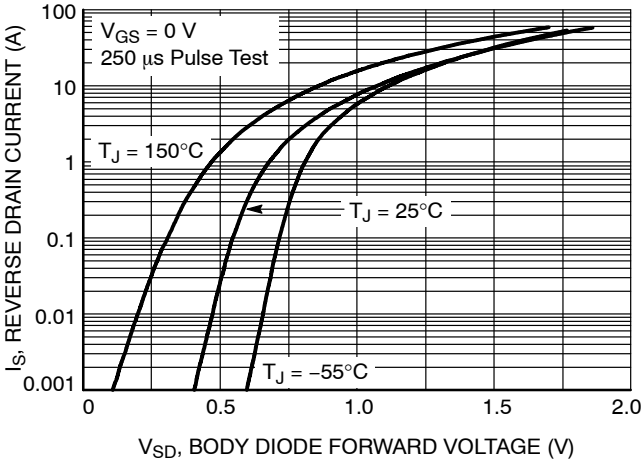



**Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature**

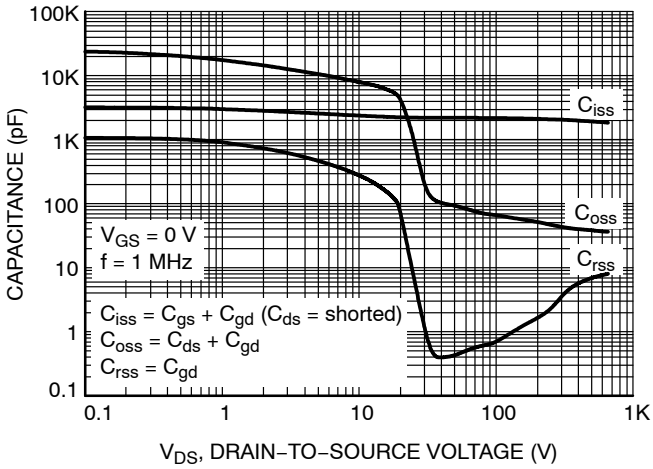



**Figure 5. Capacitance Characteristics**

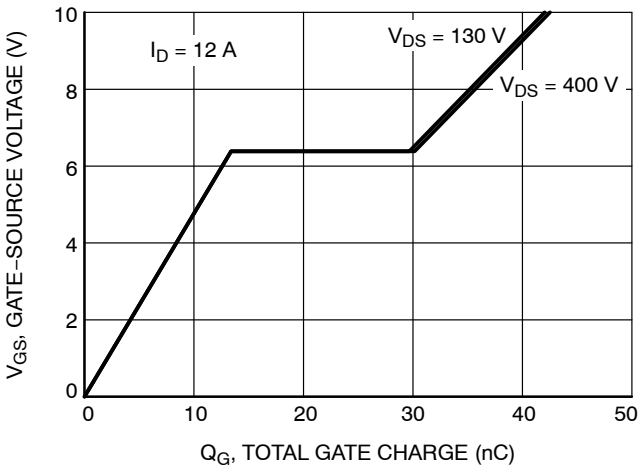



**Figure 6. Gate Charge Characteristics**



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## TYPICAL CHARACTERISTICS

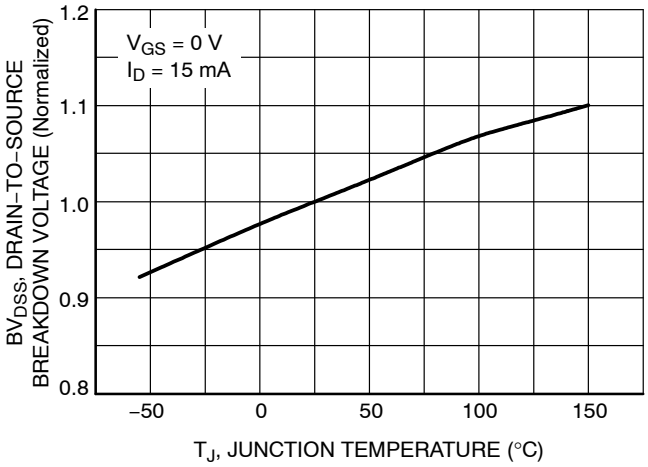



**Figure 7. Breakdown Voltage Variation vs. Temperature**

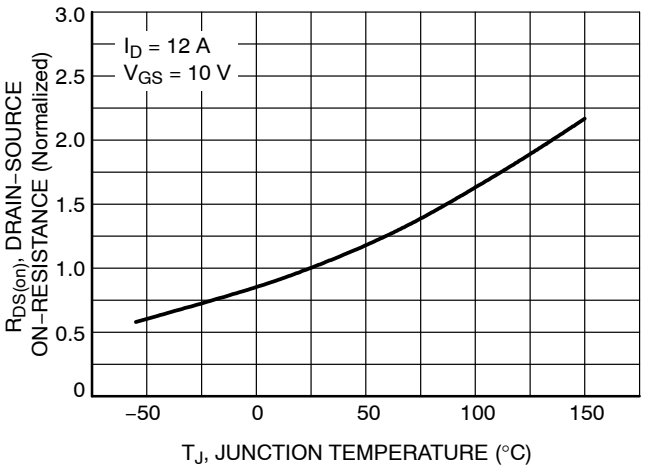



**Figure 8. On−Resistance Variation vs. Temperature**

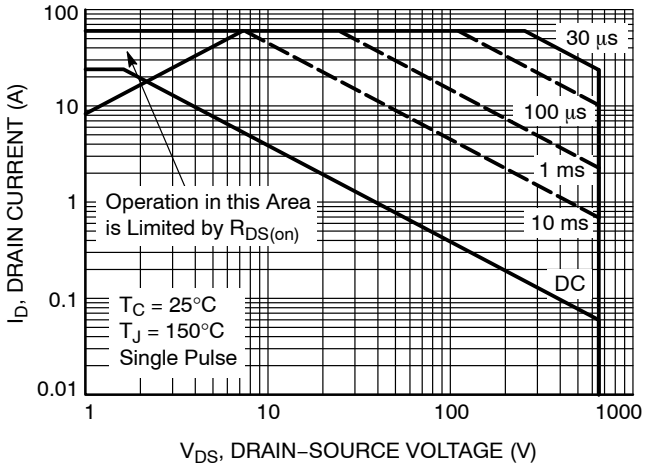



**Figure 9. Maximum Safe Operating Area**

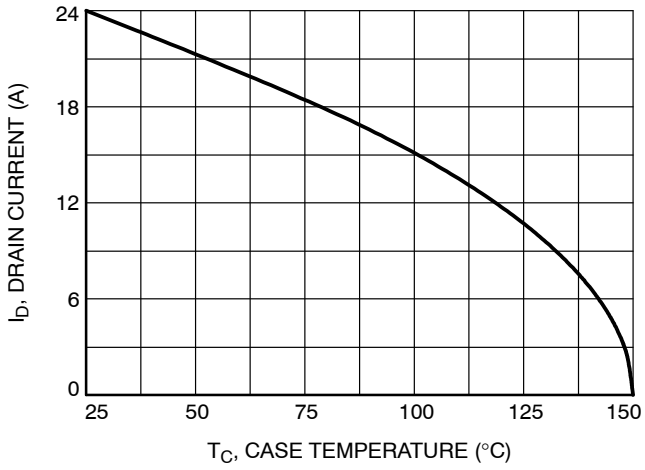



**Figure 10. Maximum Drain Current vs. Case Temperature**

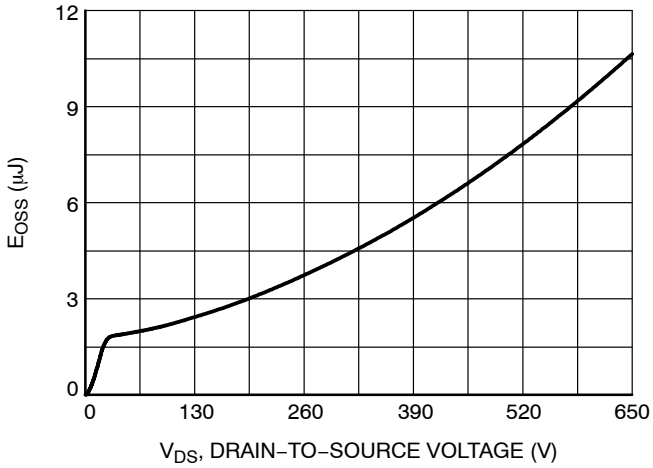



**Figure 11. $E_{OSS}$ vs. Drain−to−Source Voltage**



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## TYPICAL CHARACTERISTICS

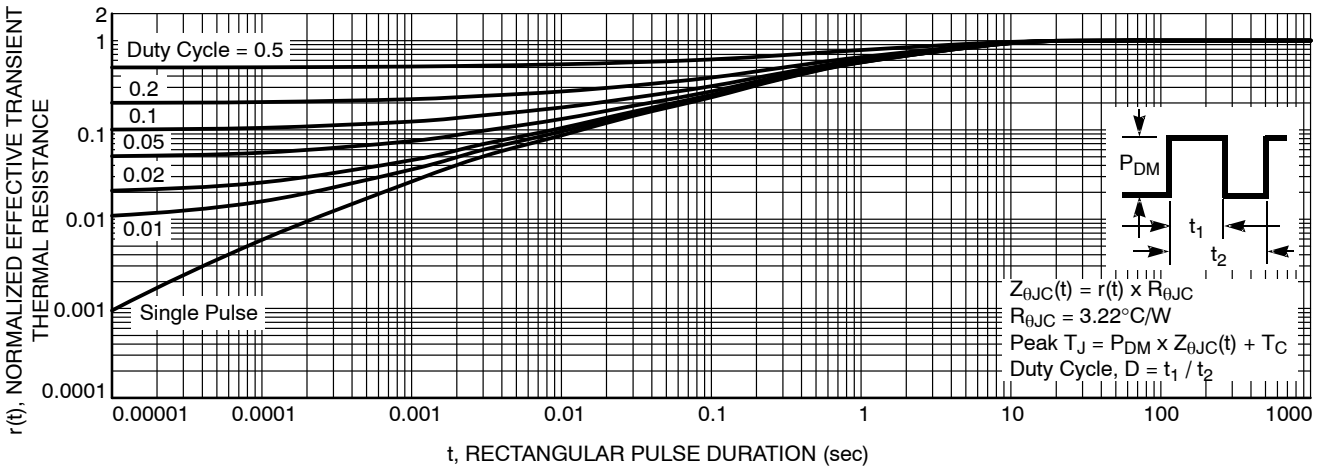



**Figure 12. Transient Thermal Response Curve**



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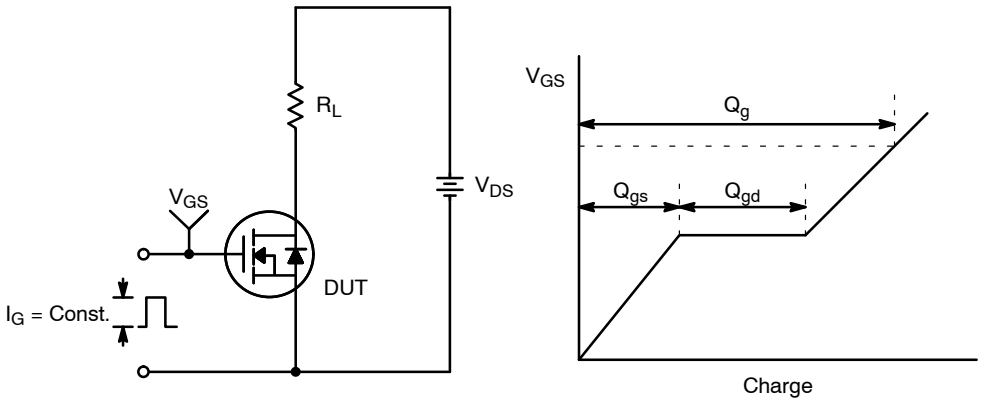



**Figure 13. Gate Charge Test Circuit & Waveform**

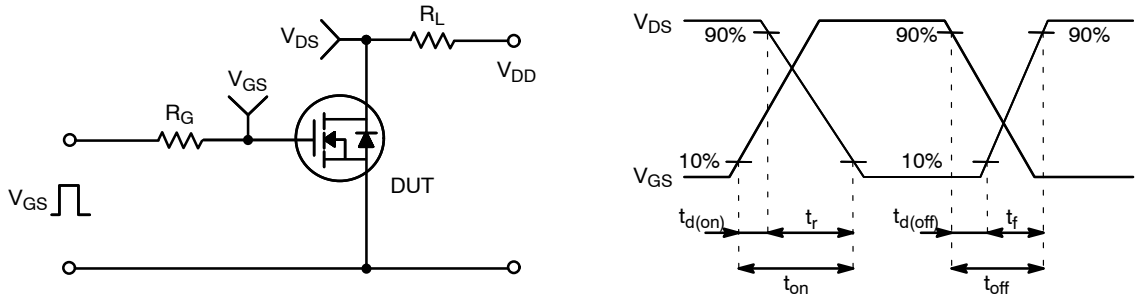



**Figure 14. Resistive Switching Test Circuit & Waveforms**

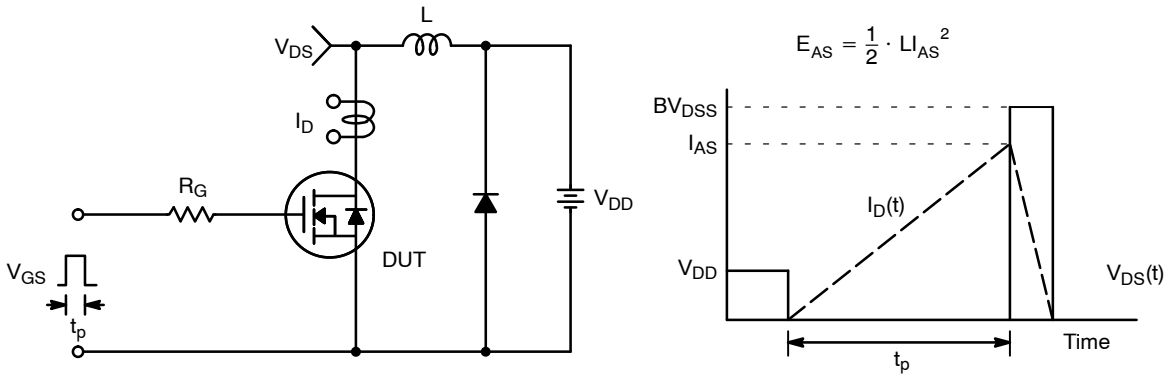



**Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms**



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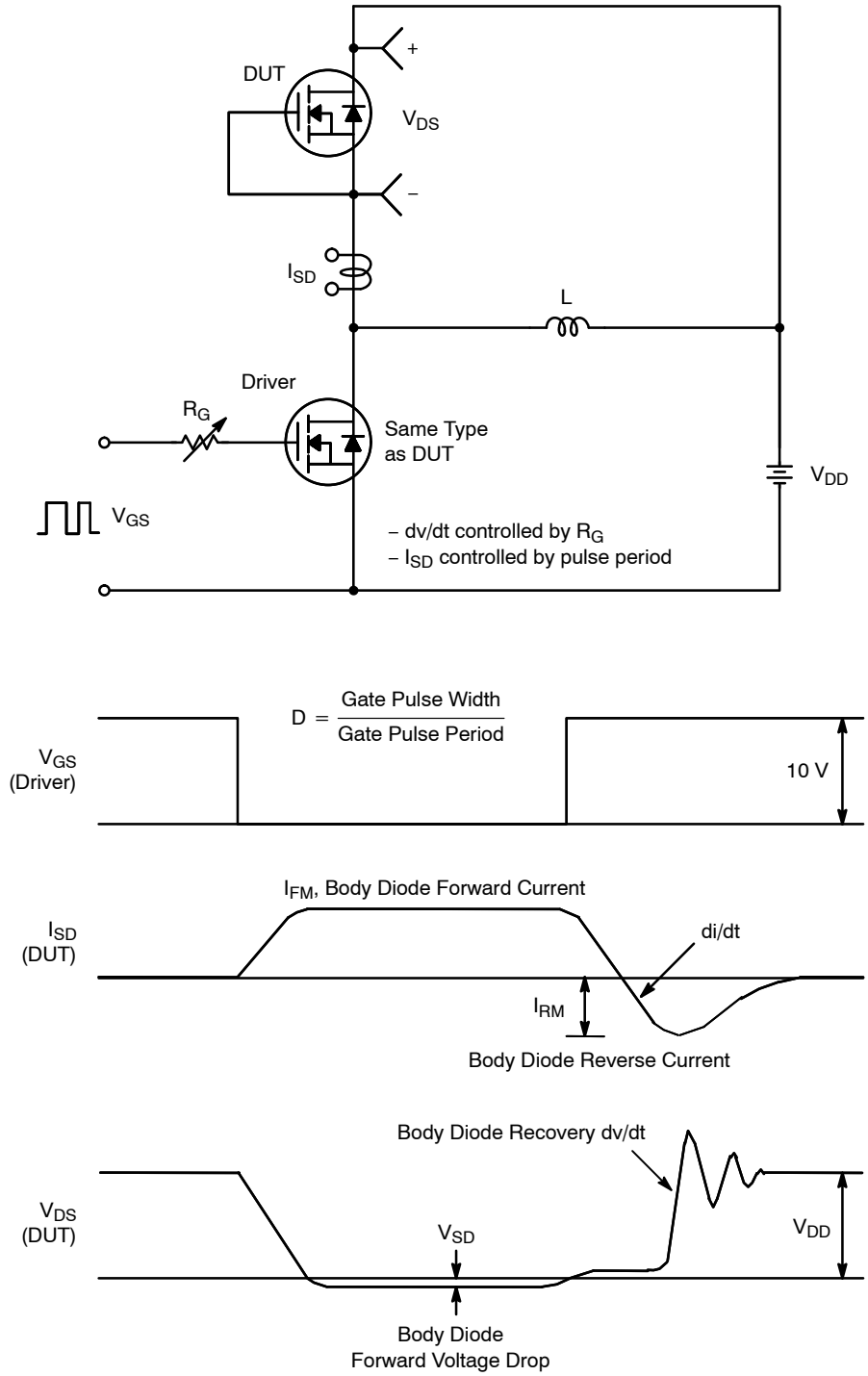
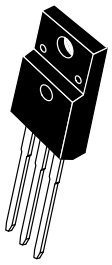



**Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms**

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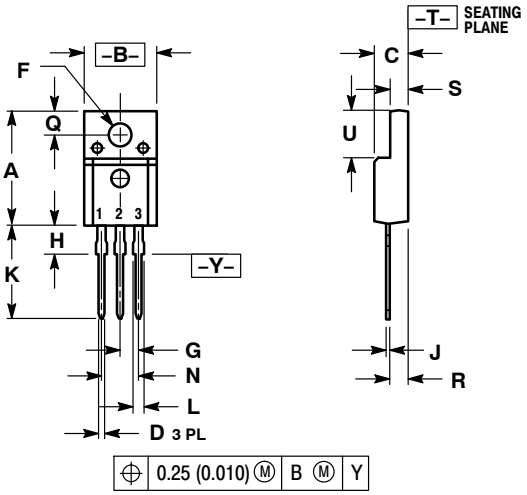
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SCALE 1:1

## TO−220 FULLPAK
CASE 221D−03
ISSUE K

DATE 27 FEB 2009




NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH
3. 221D−01 THRU 221D−02 OBSOLETE, NEW STANDARD 221D−03.

| | INCHES | | MILLIMETERS | |
|---|---|---|---|---|
| DIM | MIN | MAX | MIN | MAX |
| A | 0.617 | 0.635 | 15.67 | 16.12 |
| B | 0.392 | 0.419 | 9.96 | 10.63 |
| C | 0.177 | 0.193 | 4.50 | 4.90 |
| D | 0.024 | 0.039 | 0.60 | 1.00 |
| F | 0.116 | 0.129 | 2.95 | 3.28 |
| G | 0.100 BSC | | 2.54 BSC | |
| H | 0.118 | 0.135 | 3.00 | 3.43 |
| J | 0.018 | 0.025 | 0.45 | 0.63 |
| K | 0.503 | 0.541 | 12.78 | 13.73 |
| L | 0.048 | 0.058 | 1.23 | 1.47 |
| N | 0.200 BSC | | 5.08 BSC | |
| Q | 0.122 | 0.138 | 3.10 | 3.50 |
| R | 0.099 | 0.117 | 2.51 | 2.96 |
| S | 0.092 | 0.113 | 2.34 | 2.87 |
| U | 0.239 | 0.271 | 6.06 | 6.88 |

STYLE 1:
PIN 1. GATE
2. DRAIN
3. SOURCE

STYLE 2:
PIN 1. BASE
2. COLLECTOR
3. EMITTER

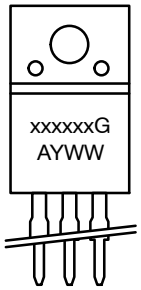
STYLE 3:
PIN 1. ANODE
2. CATHODE
3. ANODE

STYLE 4:
PIN 1. CATHODE
2. ANODE
3. CATHODE

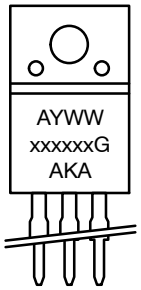
STYLE 5:
PIN 1. CATHODE
2. ANODE
3. GATE

STYLE 6:
PIN 1. MT 1
2. MT 2
3. GATE

## MARKING DIAGRAMS




**Bipolar**




**Rectifier**

| | |
|---|---|
| xxxxxx | = Specific Device Code |
| G | = Pb−Free Package |
| A | = Assembly Location |
| Y | = Year |
| WW | = Work Week |

| | |
|---|---|
| A | = Assembly Location |
| Y | = Year |
| WW | = Work Week |
| xxxxxx | = Device Code |
| G | = Pb−Free Package |
| AKA | = Polarity Designator |

| | | |
|---|---|---|
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| **DESCRIPTION:** | **TO−220 FULLPAK** | **PAGE 1 OF 1** |

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**onsemi Website:** www.onsemi.com

**ONLINE SUPPORT**: www.onsemi.com/support
**For additional information, please contact your local Sales Representative at** www.onsemi.com/support/sales

ENTEGRECİ

Bu belge www.entegreci.com üzerinden sunulmaktadır.

# Elektronik komponent tedarikinde Entegreci

Entegreci, Eskişehir merkezli, Türkiye geneline satış yapan bir elektronik komponent mağazasıdır. Entegreler (IC), mikrodenetleyiciler, transistörler, diyotlar, pasif elemanlar, konnektörler, modüller ve geliştirme kartları tek adetten seri üretim adetlerine kadar satılır. Ürün sayfalarında güncel stok durumunu, fiyatı ve datasheet bağlantısını bulabilirsiniz.

### Parça koduyla arama

Üretici parça numarasını yazın; stok ve fiyatı hemen görün.

**www.entegreci.com**

### Ürün kategorileri

Entegreden kapasitöre tüm elektronik komponent kategorileri.

**Kategorilere göz atın**

### Üreticiler

Aradığınız üreticinin ürünlerini tek sayfada inceleyin.

**Üreticileri görün**

### Toplu alım ve teklif

Listede olmayan ya da yüksek adetli parçalar için teklif isteyin.

**Teklif isteyin**

**www.entegreci.com** | **destek@entegreci.com** | **0850 305 90 34**

Entegreci is an online electronic components store based in Türkiye. Search by manufacturer part number to see stock, prices and datasheets for integrated circuits, microcontrollers, transistors, passive components and connectors, or request a quote for parts that are not listed.

Bu sayfa Entegreci tarafından eklenmiştir. Belgenin önceki sayfaları asıl yayıncısına aittir ve içeriği değiştirilmemiştir; en güncel sürüm için belgenin yayıncısına başvurun.